

Inductors for power circuits Thin-film metal magnetic material TFM-ALMA series (for automotive)









AEC-Q200

TFM252012ALMA type















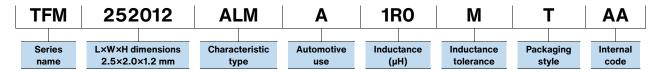
FEATURES

- By using metal magnetic material with high Saturation magnetic flux density the excellent DC bias characteristics needed for inductors for power circuits can be achieved.
- With the same product shape and terminal structure as general chip parts it has excellent mounting stability characteristics and can also be mounted to general-purpose land patterns.
- By using a closed magnetic circuit structure leakage flux is minimized.
- Compliant with AEC-Q200

APPLICATION

OADAS ECU, in-Vehicle camera (view camera, sensing camera), radar, meter cluster, automotive communication module

PART NUMBER CONSTRUCTION



CHARACTERISTICS SPECIFICATION TABLE

L		LMeasuring frequency	DC resistance		Rated current*				Rated voltage	Part No.
					Isat		Itemp			
(µH)	Tolerance	(MHz)	(mΩ)max.	(mΩ)typ.	(A)max.	(A)typ.	(A)max.	(A)typ.	(V)max.	
0.1	±20%	1	9	4	10	12	8.0	12	20	TFM252012ALMAR10MTAA
0.15	±20%	1	11	6	9.0	10	7.3	9.8	20	TFM252012ALMAR15MTAA
0.22	±20%	1	13	8	8.0	9.0	6.7	8.5	20	TFM252012ALMAR22MTAA
0.33	±20%	1	18	13	7.0	7.8	5.7	6.6	20	TFM252012ALMAR33MTAA
0.47	±20%	1	24	19	5.8	6.5	4.9	5.6	20	TFM252012ALMAR47MTAA
0.68	±20%	1	34	26	4.8	5.4	4.1	4.7	20	TFM252012ALMAR68MTAA
1.0	±20%	1	42	35	4.2	4.7	3.7	4.1	20	TFM252012ALMA1R0MTAA
1.5	±20%	1	60	52	3.3	3.9	3.1	3.3	20	TFM252012ALMA1R5MTAA
2.2	±20%	1	84	75	2.8	3.3	2.6	2.8	20	TFM252012ALMA2R2MTAA
3.3	±20%	1	140	124	2.1	2.5	2.0	2.2	20	TFM252012ALMA3R3MTAA
4.7	±20%	1	200	180	1.9	2.2	1.6	1.8	20	TFM252012ALMA4R7MTAA

^{*} Rated current: smaller value of either lsat or Itemp.

Isat: When based on the inductance change rate (30% below the nominal value)

Itemp: When based on the temperature increase (temperature increase of 40°C by self heating)

Please contact us for the rated current vs. temperature characteristics (derating) at a product temperature of 85°C or higher.

Measurement equipment

Measurement item	Product No. *	Manufacturer
L	4294A	Keysight Technologies
DC resistance	Digital Milliohm Meter	
Rated current Isat	4285A+42841A+42842C	Keysight Technologies

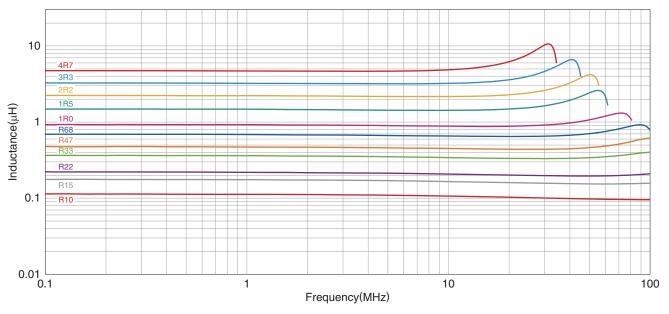
^{*} Equivalent measurement equipment may be used.





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L FREQUENCY CHARACTERISTICS

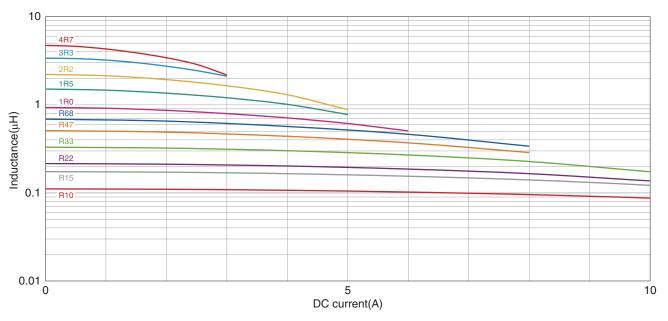


Measurement equipment

Product No. *	Manufacturer
4294A	Keysight Technologies

^{*} Equivalent measurement equipment may be used.

INDUCTANCE VS. DC BIAS CHARACTERISTICS



Measurement equipment

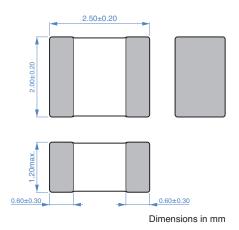
Product No. *	Manufacturer
4285A+42841A+42842C	Keysight Technologies

^{*} Equivalent measurement equipment may be used.

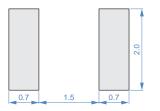


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SHAPE & DIMENSIONS

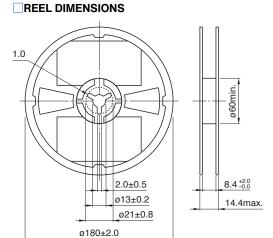


RECOMMENDED LAND PATTERN



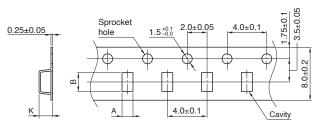
Dimensions in mm

PACKAGING STYLE



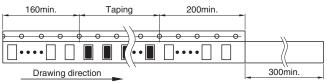
Dimensions in mm

TAPE DIMENSIONS



Dimensions in mm

Туре	Α	В	K
TFM252012ALMA	2.3	2.8	1.3



Dimensions in mm

□PACKAGE QUANTITY

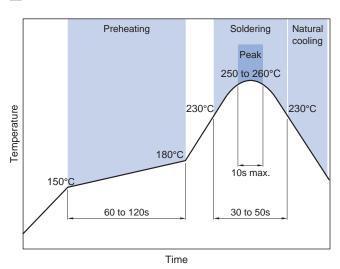
Package quantity	3000 pcs/reel

TEMPERATURE RANGE, INDIVIDUAL WEIGHT

Operating temperature range *	Storage temperature range **	Individual weight
-55 to +150 °C	-55 to +150 °C	35 mg

^{*} Operating temperature range includes self-heating.

RECOMMENDED REFLOW PROFILE



^{**} The storage temperature range is for after the assembly.



REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products

REMINDERS

The storage period is within 6 months. Be sure to follow the sRH or less).	storage conditions (temperature: 5 to 40°C, humidity: 20 to 75%
If the storage period elapses, the soldering of the terminal el	ectrodes may deteriorate.
ODo not use or store in locations where there are conditions so	uch as gas corrosion (salt, acid, alkali, etc.).
Before soldering, be sure to preheat components. The preheating temperature should be set so that the tempe temperature does not exceed 150°C.	erature difference between the solder temperature and chip
Soldering corrections after mounting should be within the rail overheated, a short circuit, performance deterioration, or I	· · · · · · · · · · · · · · · · · · ·
When embedding a printed circuit board where a chip is mou due to the overall distortion of the printed circuit board and	inted to a set, be sure that residual stress is not given to the chip partial distortion such as at screw tightening portions.
Self heating (temperature increase) occurs when the power i thermal design.	s turned ON, so the tolerance should be sufficient for the set
Carefully lay out the coil for the circuit board design of the new Amalfunction may occur due to magnetic interference.	on-magnetic shield type.
Ouse a wrist band to discharge static electricity in your body t	hrough the grounding wire.
ODo not expose the products to magnets or magnetic fields.	
ODo not use for a purpose outside of the contents regulated ir	the delivery specifications.
where the said automotive product is mounted in a vehicle) of automotive applications or standard applications as general of the scope and conditions described in this specification, while said product is intended to be used in the usual operation are automotive products are not designed or warranted to meet performance and/or quality requires a more stringent level of cause serious damage to society, person or property.	es, amusement equipment, computer equipment, personal ustrial robots) and to be used in automobiles (including the case or standard applications as general electronic equipment in electronic equipment in automotive applications in accordance with the the said automotive or general electronic equipment including the old usage methods, respectively. Other than automotive or the requirements of the applications listed below, whose of safety or reliability, or whose failure, malfunction or defect could
below or for any other use exceeding the range or condition	e or liability caused by use of the products in any of the applications s set forth in this specification sheet. Flow or if you have special requirements exceeding the range or
conditions set forth in this specification, please contact us.	
(1) Aerospace/aviation equipment (2) Transportation equipment (electric trains, ships, etc.)	(7) Transportation control equipment (8) Public information-processing equipment

- (3) Medical equipment
- (4) Power-generation control equipment
- (5) Atomic energy-related equipment
- (6) Seabed equipment

- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.